

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application

Kokkie SCHNETZ et al.

Application No.: 10/584,068

Examiner: Edna Wong

Filed: June 22, 2006

Group Art Unit: 1795

For: IMPROVED METAL STRIP ELECTROPLATING

**AMENDMENT**

DO NOT ENTER: /EW/

12/18/2008

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In response to the Final Office action mailed September 16, 2008, please amend the above-identified application as follows: